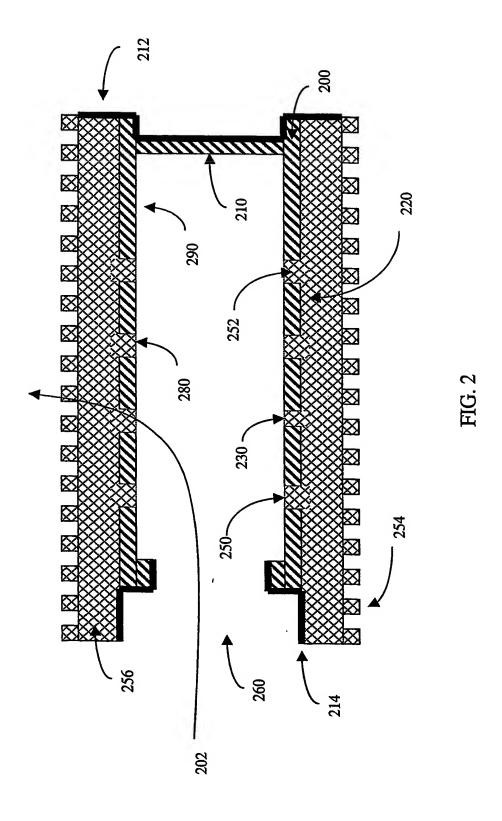


FIG. 10



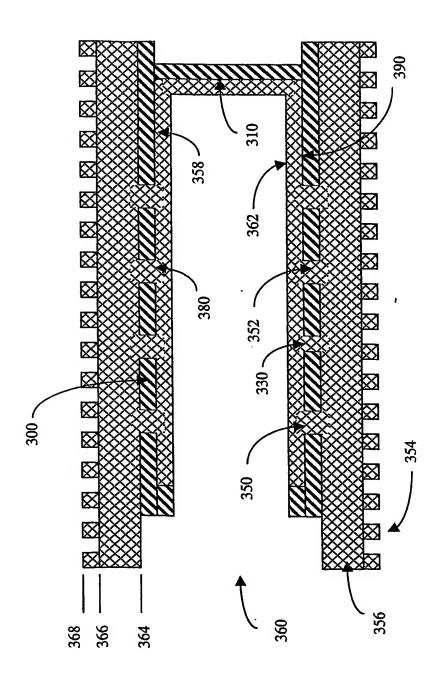


FIG. 3A

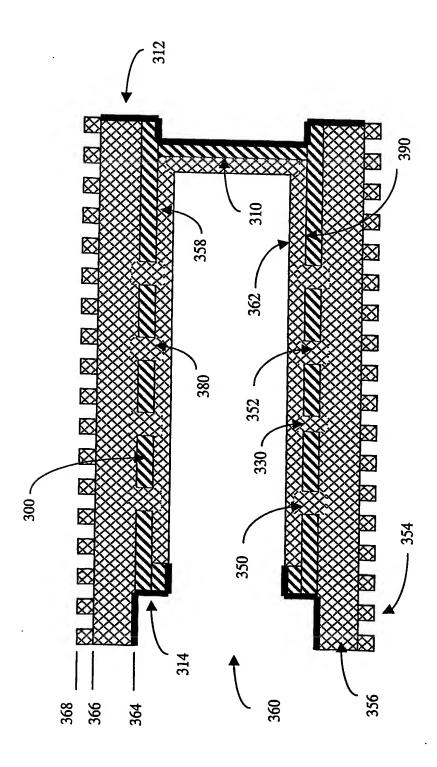


FIG. 3B

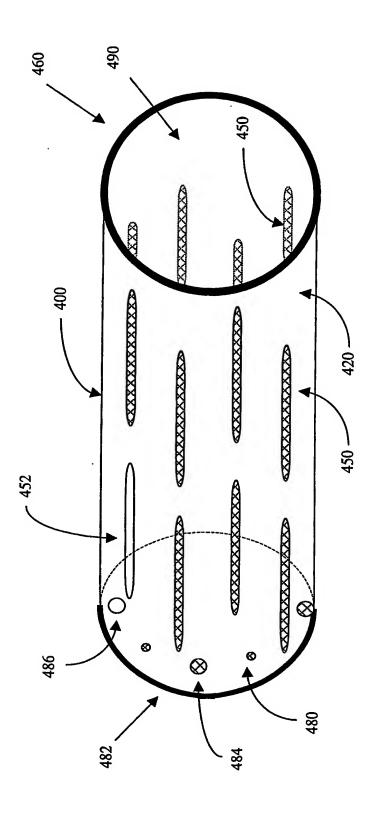


FIG. 4

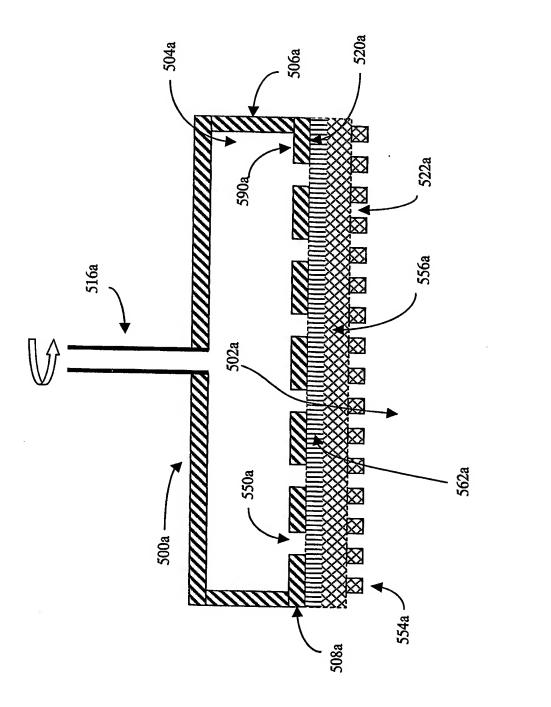


FIG.

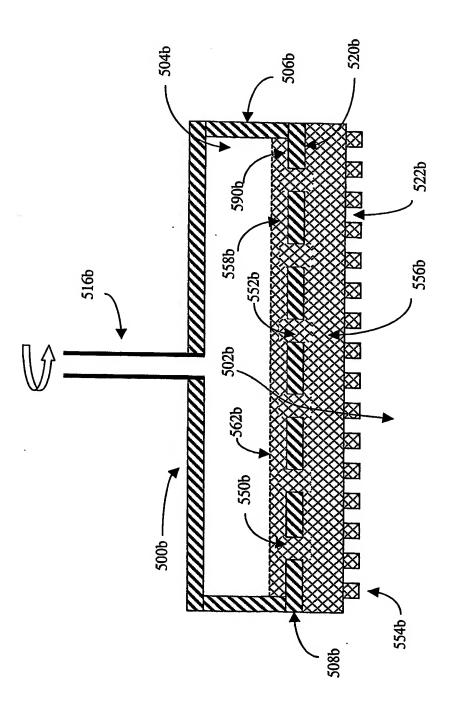
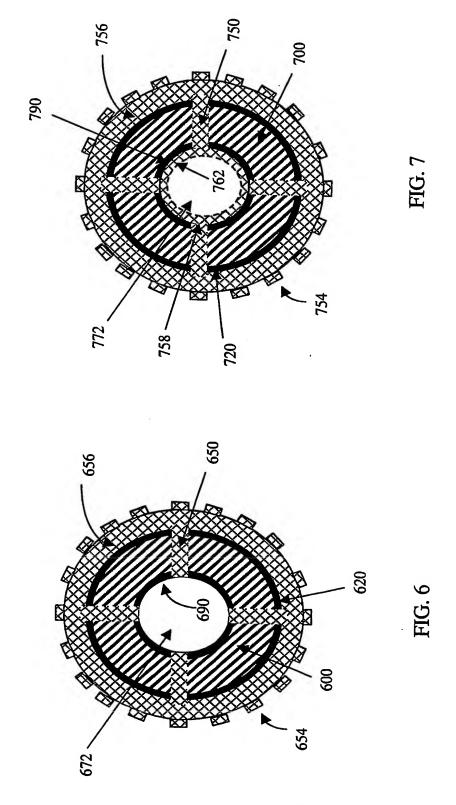
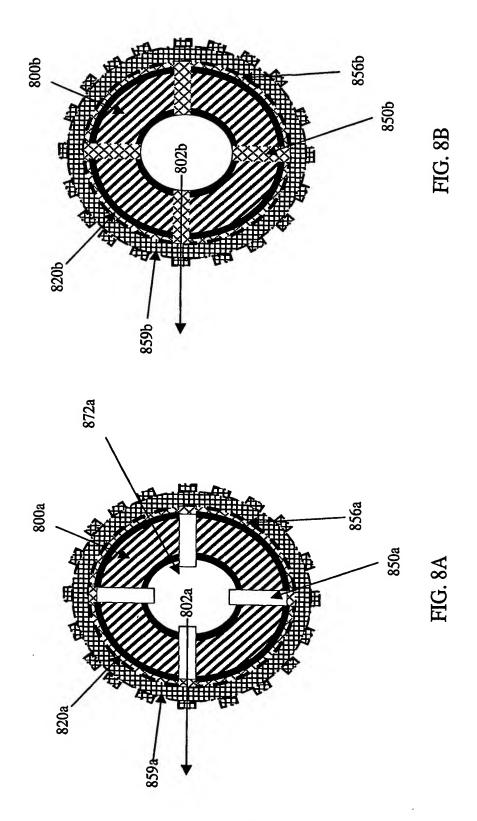
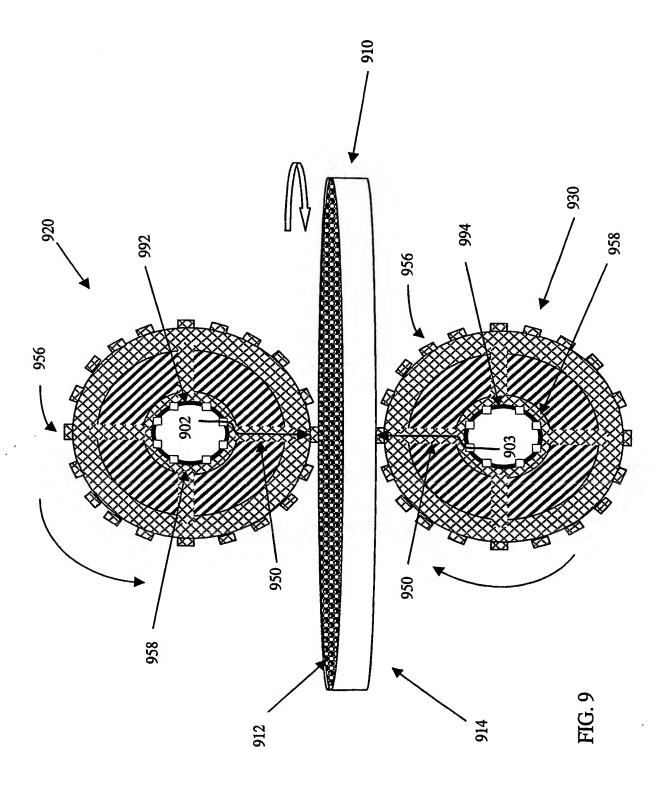


FIG. SE

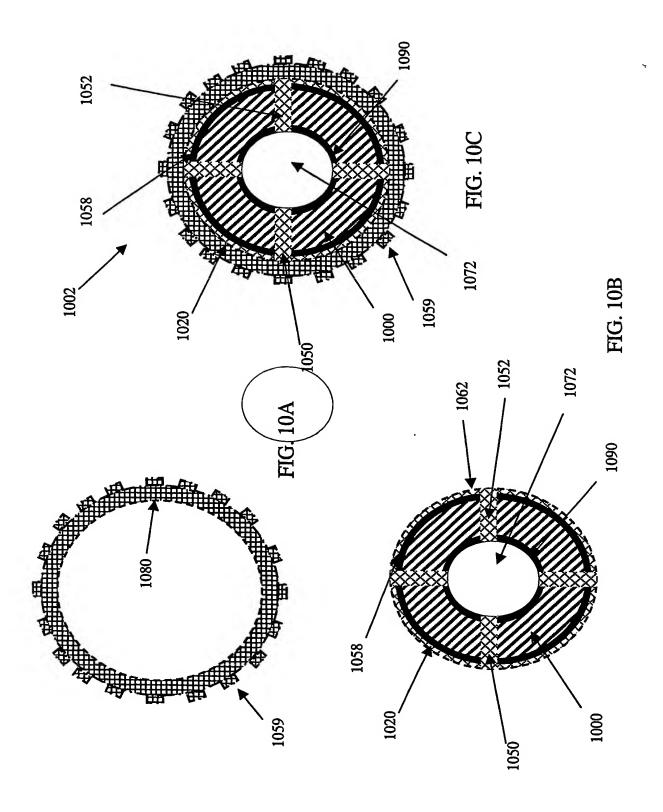


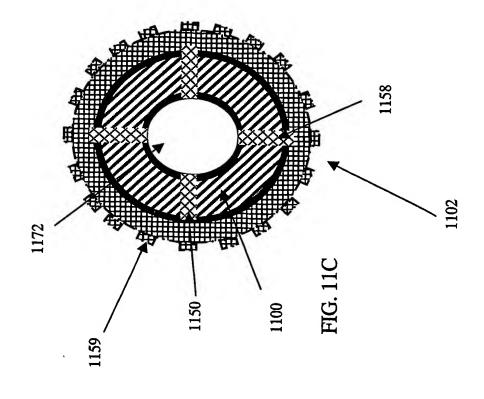


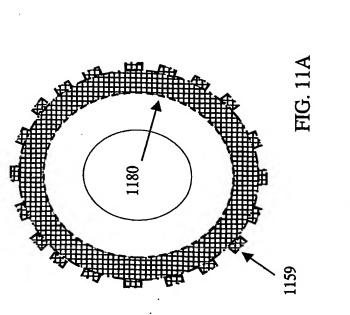
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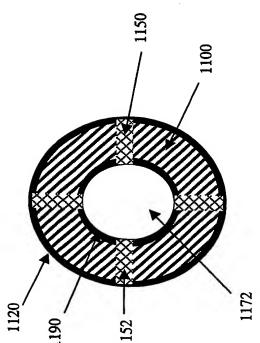


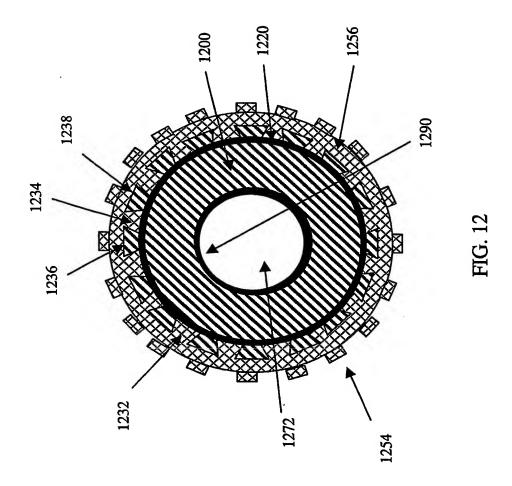
WO 2005/016599



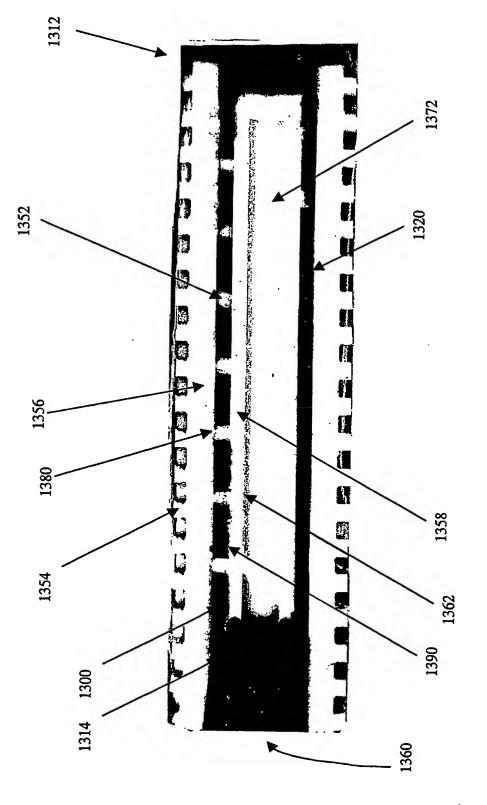








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FIG

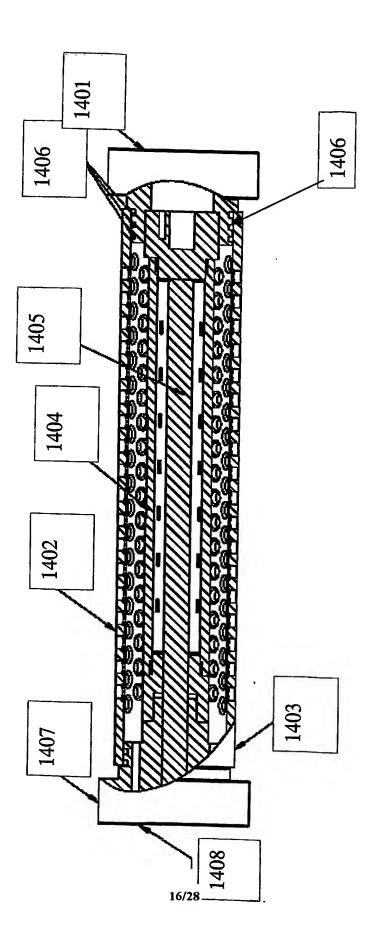
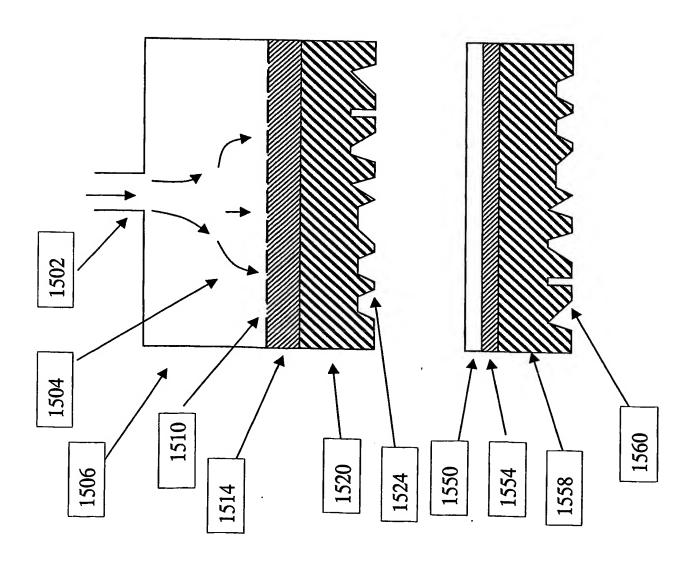


FIG. 14



FIG. 15 B



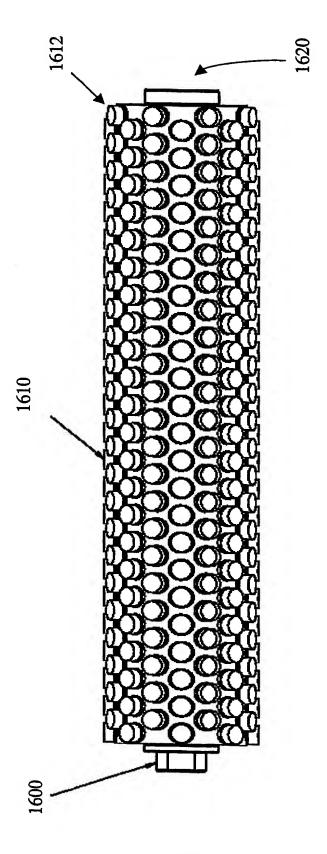
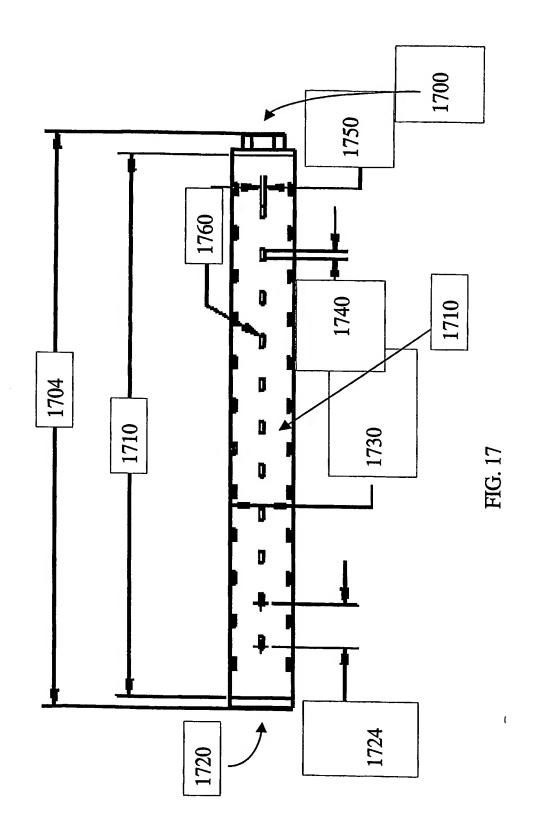
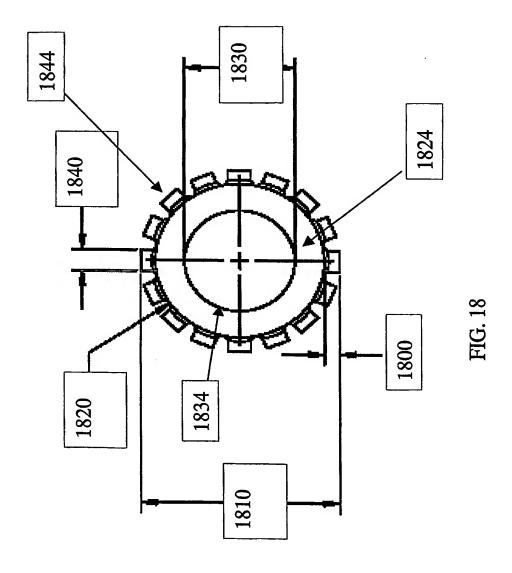


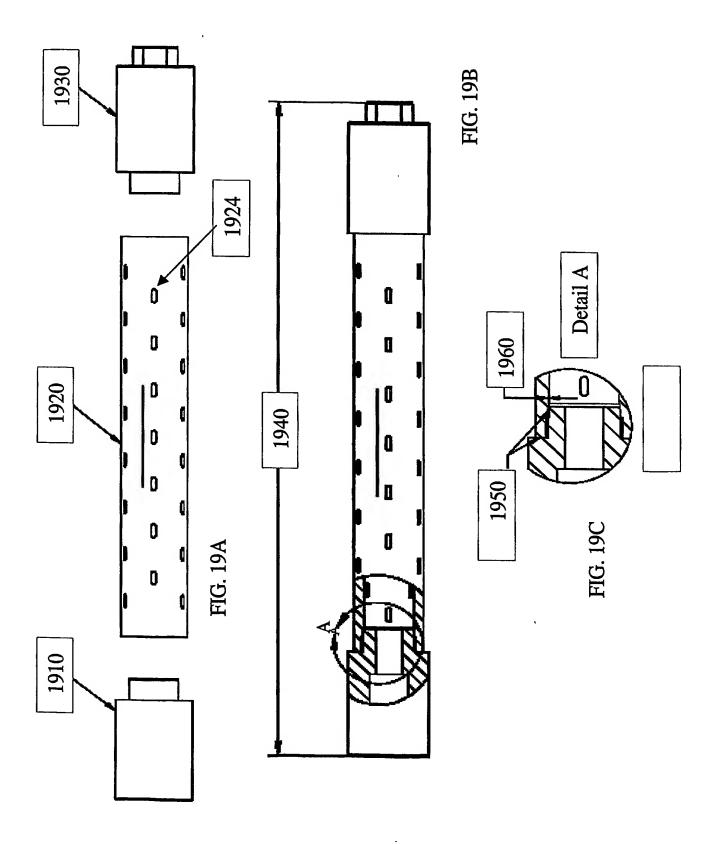
FIG. 1

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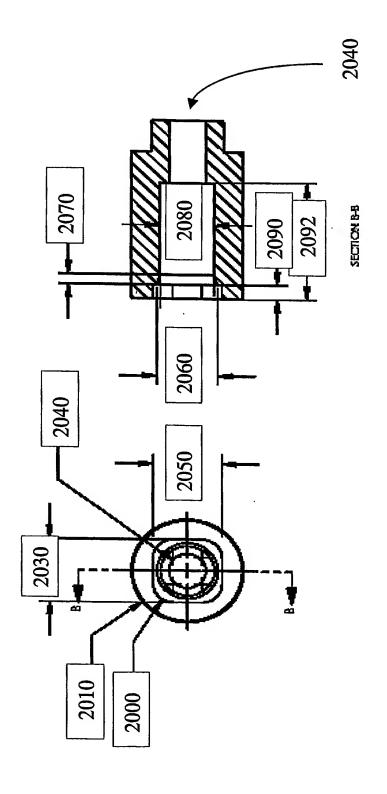
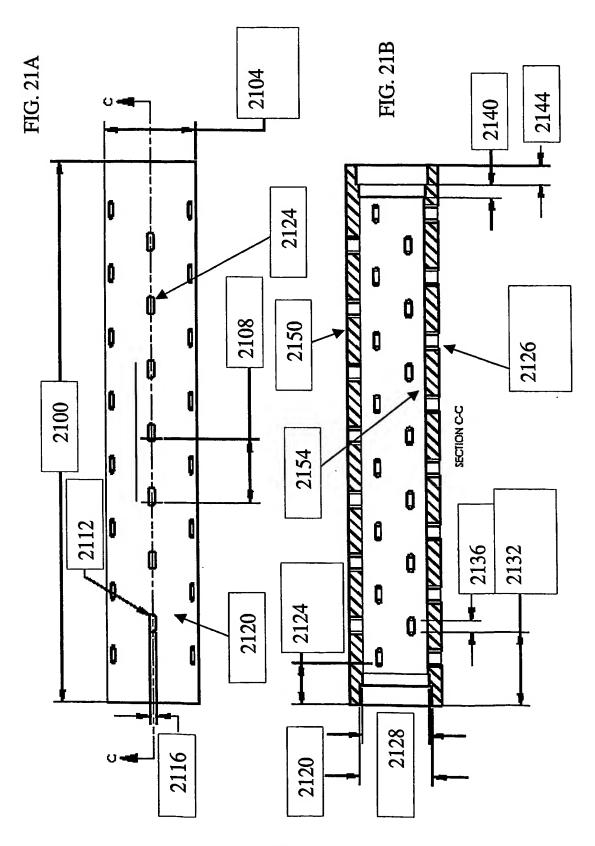
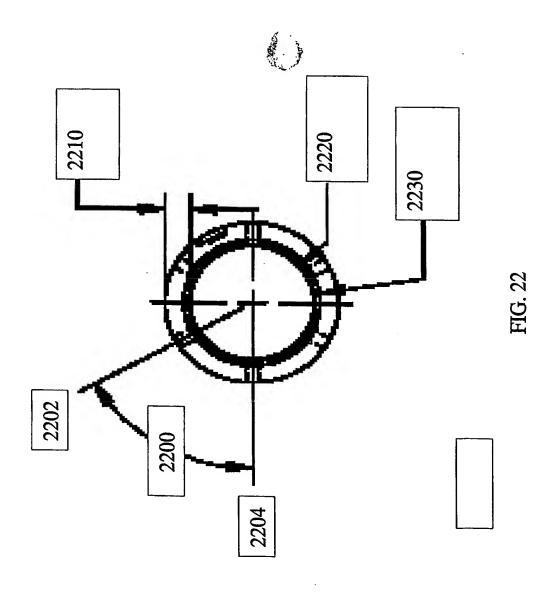


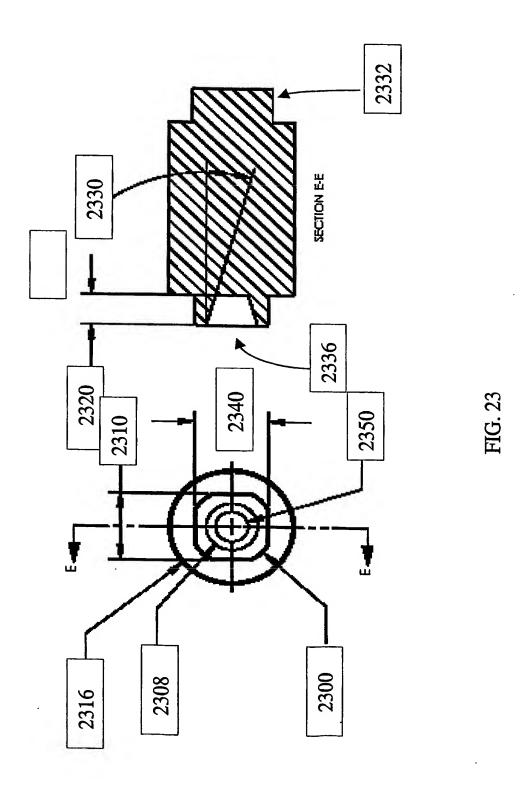
FIG. 20

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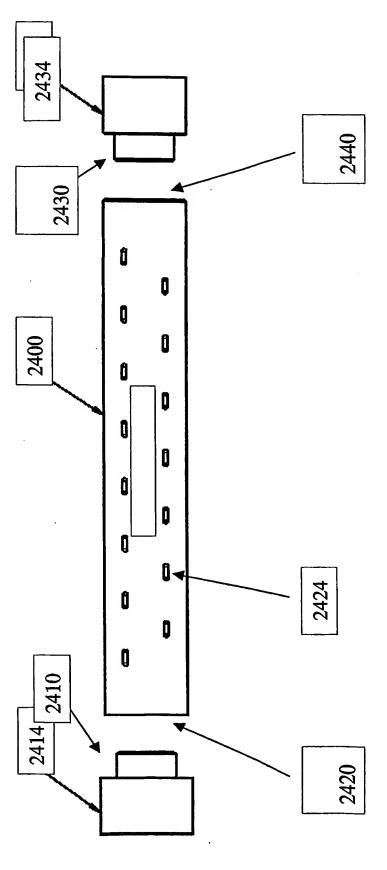
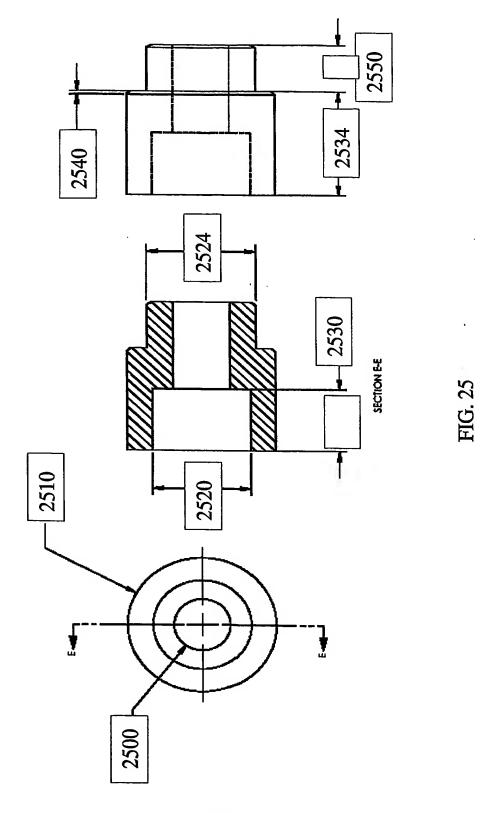
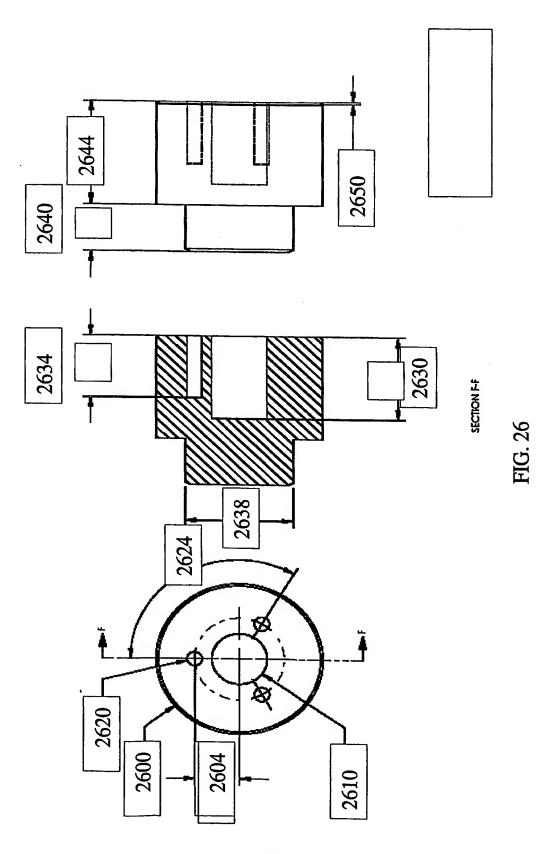


FIG. 24



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